

# HSF

Recommended P.C.B Layout(Top Side)  
(PCB BOARD TOLERANCE±0.05)

**NOTES:**

Current Rating: 3.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 1000V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au Or Sn over Ni  
 Insulator Material: PA9T+30%G.F. UL94V-0

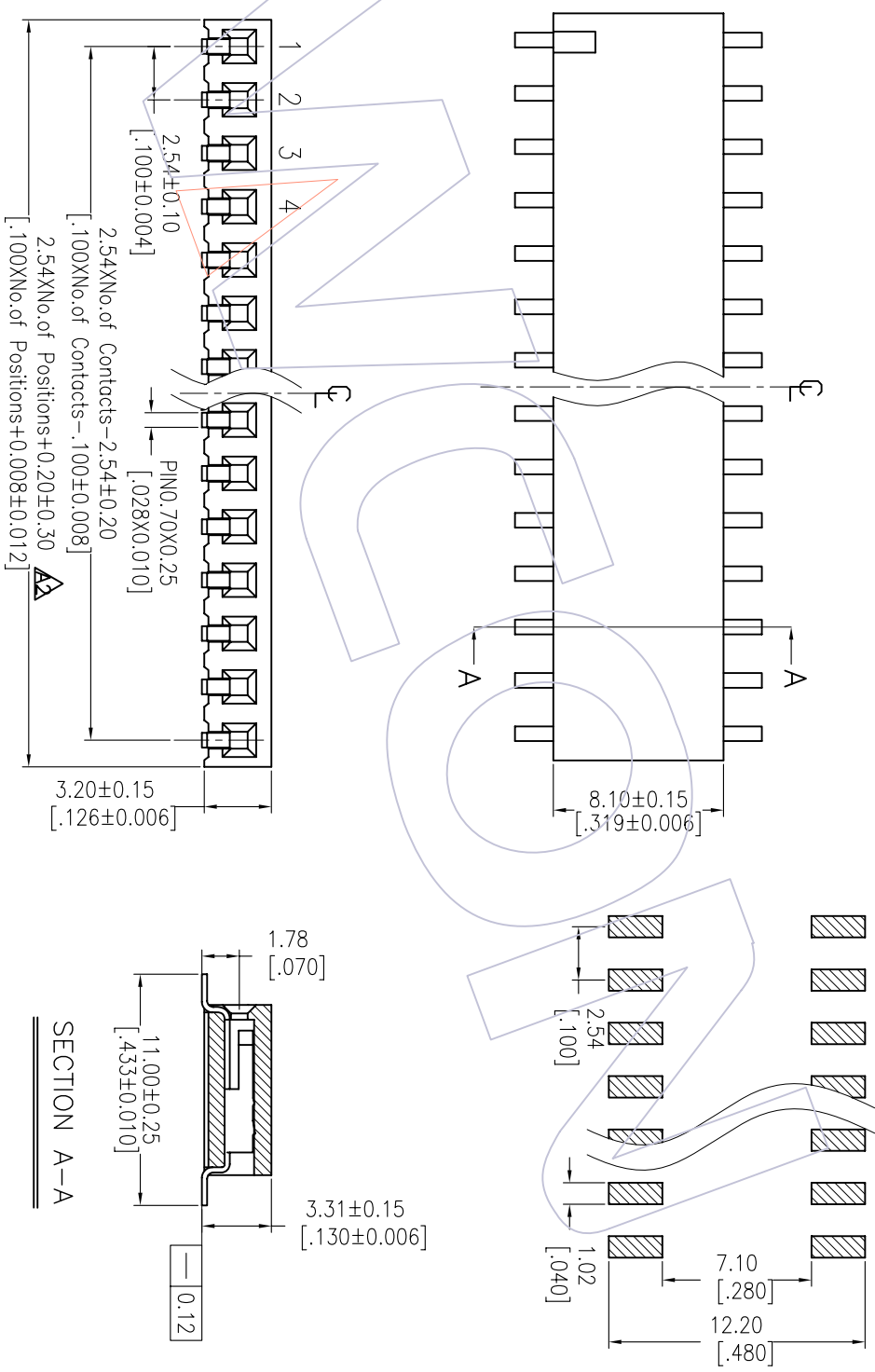
## Ordering Information

2134-1XX M XX CUNX1

No. of Pins per Row: 02-40PIN  
 Contact Plating:  
 G0=Gold Flash  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold  
 S0=Gold Flash/Tin  
 S3=10μ"Gold/Tin  
 S4=15μ"Gold/Tin  
 S5=30μ"Gold/Tin  
 SN=Tin  
 SM=Matte Tin

Packing:  
 T=Tube  
 R=Tray/Reel

Item	Pitch	Mating
Standard	2.54	1125B
Alternate		△



SECTION A-A

OPERATION		DRAW		DATE		SCALE		PART NO.	
XX		JYHuang		2012/09/20		FIT		2134-1XXMXXCUNX1	
±0.40		CHECK		DATE		mm		TITLE:	
±0.25		X.XXX		±0.15		A4		FH2.54 SINGLE ROW 180° SMT	
±0.15		X.XXX		±0.15		SHEET		SIDE ENTER H=3.2	
Angle		APPROVE		DATE		1/1		Customer NO.	
± 3°		PROJ.		PROJ.		1/1			
TOL		CHANGE		CHANGE		DIM			
MODIFICATION DESCRIPTION		MODIFY ADD +0.20		Change the mating object		NEW			
DATE		2012/09/20		2012/08/24		2012/08/02			
REV		A2		A1		A0			

# WCON

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